



PPLICANT(S)

: WONG, Tit Shing

APPLICATION NO. : 10/618,985

DATE FILED

: 07/14/2003

FOR

: THERMOPLASTIC MOLDING PROCESS

GROUP ART UNIT : 1732

EXAMINER: BECK, David T.

ATTY DOCKET NO.: ²JETTA-003US

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

AUTHORIZATION TO CHARGE DEPOSIT ACCOUNT

SIR:

In the above-identified application, the Commissioner is hereby authorized to charge any additional fees due in connection with the July 14, 2005 submission of a Response (included herewith) to the Office Action mailed April 18, 2005, or to credit any overpayment relating to the same, to Deposit Account No. 04-0838.

Respectfully submitted,

COLEMAN SUDOL SAPONE, P.C.

Dated: July 14, 2005

Reg. No. 32,559

714 Colorado Avenue Bridgeport, CT 06605

(203) 366-3560

Applicant: T. S. Wong Application No.: 10/618,985

Filed: July 14, 2003

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:

T. S. Wong.

Application No.:

10/618,985

Group Art Unit: 1732

Filed:

July 14, 2003

Examiner: David T. Beck

Title:

THERMOPLASTIC MOLDING PROCESS

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EXPRESS MAIL NO.

DEPOSITED: July 17, 2005

I hereby certify that this correspondence is being deposited with the United States Postal Service Express Mail under 37 C.F.R.§ 1.10 on the date indicated above and is addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria VA 22313-1450,

MS Amendment.

WRTIS SCHRANDT

MS Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria VA 22313-1450

RESPONSE

Sir:

This Response is submitted in reply to the April 18, 2005 Office Action ("Office Action") issued in connection with the above identified patent application. Please amend the application as follows.